Switching Diodes Silicon Epitaxial Planar

1SS302A

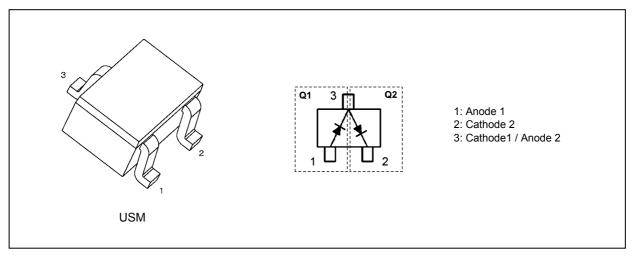
1. Applications

• Ultra-High-Speed Switching

2. Features

- (1) Fast reverse recovery time : $t_{rr} = 1.6$ ns (typ.)
- (2) AEC-Q101 qualified

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Rating	Unit
Peak reverse voltage	V _{RM}		85	V
Reverse voltage	V _R		80	
Peak forward current	I _{FM}	(Note 1)	300	mA
Average rectified current	I _O	(Note 1)	100	
Power dissipation	PD	(Note 2)	100	mW
Non-repetitive peak forward surge current	I _{FSM}	(Note 1), (Note 3)	2	А
Junction temperature	Tj		150	°C
Storage temperature	T _{stg}		-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Unit rating. Total rating = Unit rating \times 70%

Note 2: Mounted on a glass epoxy circuit board of 20 mm \times 20 mm, Pad dimension of 4 mm \times 4 mm.

Note 3: Measured with a 10 ms pulse.

Start of commercial production

2014-12

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5. Electrical Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward voltage	V _{F(1)}	I _F = 1 mA	_	0.60	_	V
	V _{F(2)}	I _F = 10 mA		0.72	_	
	V _{F(3)}	I _F = 100 mA		0.90	1.20	
Reverse current	I _{R(1)}	V _R = 30 V	_	_	0.1	μA
	I _{R(2)}	V _R = 80 V	_	—	0.5	
Total capacitance	Ct	V _R = 0 V, f = 1 MHz	_	0.9	3.0	pF
Reverse recovery time	t _{rr}	I _F = 10 mA See Fig. 5.1.		1.6	4.0	ns

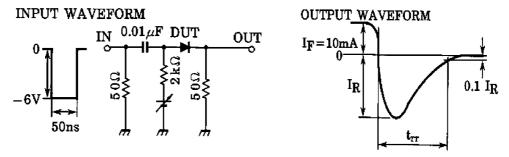
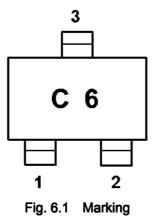
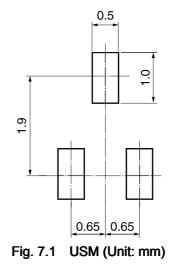


Fig. 5.1 Reverse recovery time (t_{rr}) Test circuit

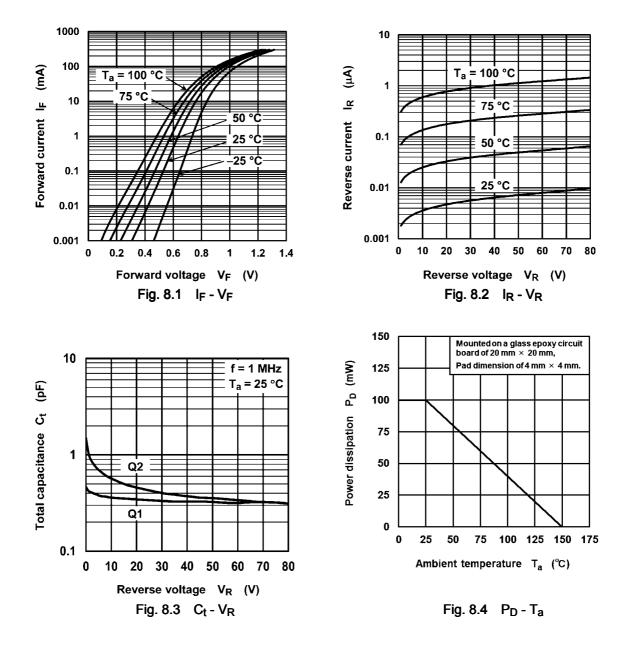
6. Marking



7. Land Pattern Dimensions (for reference only)



8. Characteristics Curves (Note)

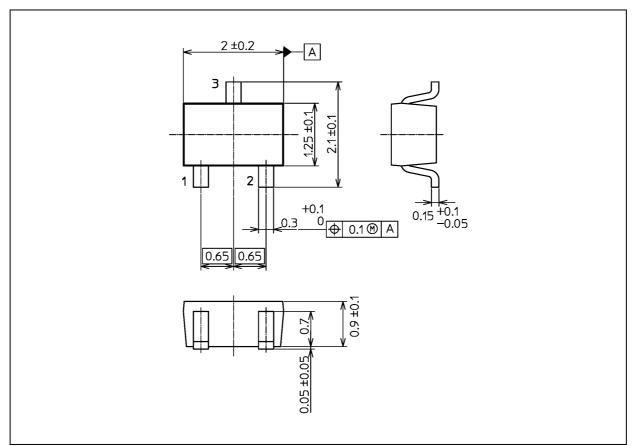


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

1SS302A

Package Dimensions

Unit: mm



Weight: 6.0 mg (typ.)

	Package Name(s)
TOSHIBA: 2-2E1S	
Nickname: USM	

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